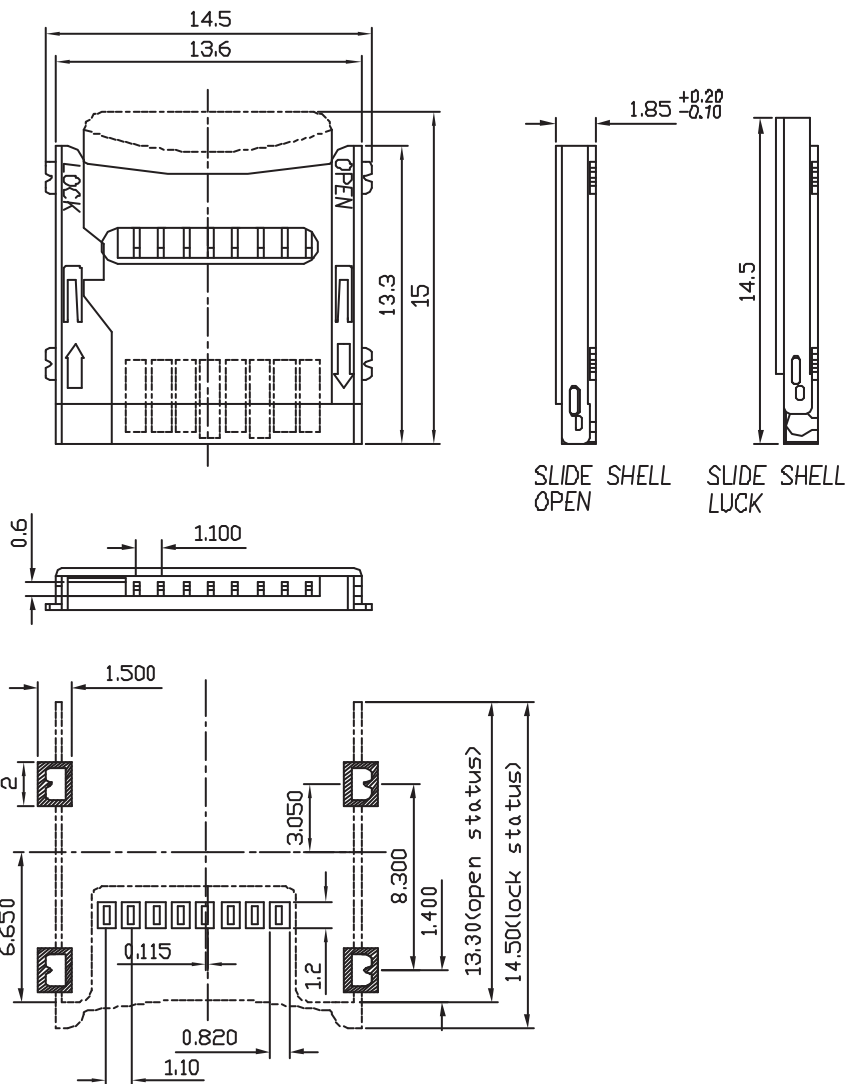


1 2 3 4 5 6 7 8

REV	MODIFICATION	DATE	DRAW

F  
E  
D  
C  
B  
A



REFERENCE PCB LAYOUT

Specification:

Withstanding Voltage: 500VAC Max with 1 Minute  
 Insulation Resistance: 1000MΩ min  
 Ratings  
 Voltage : 100 Volts DC, AC(rms) 100 Volts (per pin)  
 Current : 0.5 Amperes DC (per pin)  
 Operating Temperature : -25C~+85C  
 Contact Retention Force: 100 Gram(0.98N) min  
 Insertion Force: 15N Max  
 Separation Force: 15N Max  
 Insertion Cycles: 5000 Times

Ordering Information:

TFDMF-108 XX BT00  
 05-- 5u" Gold Plating  
 10-- 10u" Gold Plating  
 15-- 15u" Gold Plating

DIMENSION IN mm [Inch]		PROD. SPEC.	ALMITA CO., LTD.	
TOLERANCE UNLESS OTHERWISE SPECIFIED		PKG. SPEC.	TITLE	CUSTOMER DRAWING
.X±0.05	X'±	APPROVE	TRANS FLASH CARD CONNECTOR HINGE TYPE	
.XX±0.05	.X'±	CHECK	FILE NO.	DWG NO. TFDMF-108XXBT00
.XXX±0.05	.XX'±	DRAW	SIZE	A4
			PROJ.	SHEET 1 / 1
			SCALE	3:1
			REV	A

1 2 3 4 5 6 7 8 8F-01-R10